

ARKA JAIN UNIVERSITY

TRAINING & PLACEMENT DEPARTMENT

PLACEMENT DRIVE: High-Tech next engineering & Telecom PVT. Ltd.

COMPANY PROFILE

High-Technext Engineering & Telecom Pvt Ltd. Formed in 2012 by a highly innovative team & became private limited company in the year 2013. High-Technext is a leading provider of Telecom Infrastructure in India from Telecom Network Planning & Design to Operations & Maintenance. We offer a complete range of telecom services in various part of India and abroad, that include world-class passive Telecom Infrastructure, Telecom Network Planning, Design and Operations & Maintenance services. High-Technext is a leading one-stop shop for telecom infrastructure and engineering offering services including Project Management, Radio Frequency (RF) Engineering, Telecom Tower Design & Supply, Telecom Shelters, Engineering Constructions & Projects, Engineering Services and Operations & Maintenance.

ORGANIZATION	:	High-Tech next engineering & amp; Telecom PVT. Ltd.
WEBSITE	:	www.hitechnext.com
JOB TITLE	:	Site Engineer (Trainee)
JOB TYPE	:	Full Time
LOCATION	:	West Bengal / Odisha / Bihar/ Jharkhand / Punjab /Haryana/ UP/ Rajasthan/ Delhi-NCR [PAN India]
ELIGIBILITY CRITERIA	:	ME AND EEE
STIPEND OFFERED	:	Rs 8,000/- to 12,000/- per month [For Diploma Engineers] + Accommodation + Transportation + Insurance [Worth Rs. 1Lac] +PF+ESI

JOB REQUIREMENT

- Candidates must have to physically fit.
- The candidate will be responsible for various RF/wireless activities like survey, planning, Installation, commissioning, spectrum analysis, Installation & Commissioning BTS sites etc.
- Candidates must have the ability for providing Telecom solutions i.e. Tele solution of different kind of errors in GSM and CDMA spectrum.
- Candidate should have the ability to work under pressure.
- Candidate should have the leadership quality to maintain team.
- Candidates willing relocate.

JOB DETAILS

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RF Survey, EMF Survey, LOS Survey, UBR Survey, BTS Installation & Commissioning, Microwave Link, 3G & 4G Implementation, Small Cell Project, Battery Bank Installation

OTHER SKILLS

- Good eyesight
- Excellent communication and interpersonal skills
- Analytical and problem-solving skills
- Good organizational and managerial skills
- Presentation skills
- A logical approach to problem solving
- To enjoy technical and engineering activities
- To be able to keep up-to-date with rapid technological developments
- To be able to work as part of a team

Essential Duties and Responsibilities:

- Carrying out site surveys
- May have to visit sites when needed to solve problems regarding communicating devices.
- Will have to inspect and service telecommunication devices in frequent interval of time.
- Engineers will also have to designed create devices for telecommunication systems and cooperate with the team members.
- Traveling to meet suppliers, customers and colleagues based in other offices
- Negotiating product requirements with customers
- Providing technical guidance to colleagues and other teams
- Finding creative solutions to the challenges of network design, mobile communications, data service requirements and internet and network signaling protocols
- Testing theoretical designs
- Attending conferences and seminars to network and keep up to date with the latest developments in the sector
- Liaising with internal and external customers
- Analyzing and interpreting data to inform your work
- Working to tight timescales as part of a high-performing team
- Arranging process meetings
- Rewriting or modifying processes to ensure all aspects of the service run smoothly and to schedule.

SELECTION PROCESS

1. Offline Written Test,GD,PI

Bond

One thing we would like to inform you about the bonding procedure of our company. Every selected candidate has to sign a bond with our company for 1 year. They can't leave the service before 1 year. **For the bonding procedure candidates have to deposit a amount of Rs. 20,000/- as security money which will be refunded to them after 1 year of successful service in the company. This amount is taken due to training & Telecom Equipment (GPS, Digital Camera, Tracker, Tablet, Laptop, Mirror Compass, Safety Kits, Etc.) purpose.** The whole matter will be written on the stamp paper that the employee has submitted the amount to the company & company will return the amount to them after

completion of 1 year of service in the company. Please aware the candidates about the bonding procedure clearly & those who are willing for the bonding procedure please process their profile to us.

PROCESS OF REGISTRATION

1. E-mail your nomination to placements@arkajainuniversity.ac.in
2. Subject line of your E-mail must be mentioned as “RESUME High-Tech next engineering & Telecom PVT. Ltd.”.
3. Resume must be in the MS Word format. Resume file name must be student’s own name.
4. Resumes in any other format will be rejected.
5. Submission of resume in prescribed format should be done before 10:00 am, 11th December 2019.

Sd/-

HEAD – TRAINING & PLACEMENTS